

Form PTO-1595
0077.0079

U.S. DEPARTMENT OF COMMERCE
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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

<p>1. Name of conveying party(ies): Execution Date</p> <p>1) Fay Hua, 1) September 1, 2004, 2) Thomas J. Fitzgerald, 2) September 3, 2004, 3) Carl L. Deppisch, 3) September 2, 2004, 4) Gregory M. Chrysler 4) September 2, 2004</p> <p>Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>	<p>2. Name and address of receiving party(ies):</p> <p>Intel Corporation 2200 Mission College Blvd., Santa Clara, CA 95052</p> <p>Additional name(s) & address(es) attached? <input type="checkbox"/> Yes <input checked="" type="checkbox"/> No</p>
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<p>3. Nature of conveyance:</p> <p><input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other _____</p>	
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4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: _____

<p>A. Patent Application No.(s): 10/871,978, filed June 18, 2004</p>	<p>B. Patent No.(s):</p>
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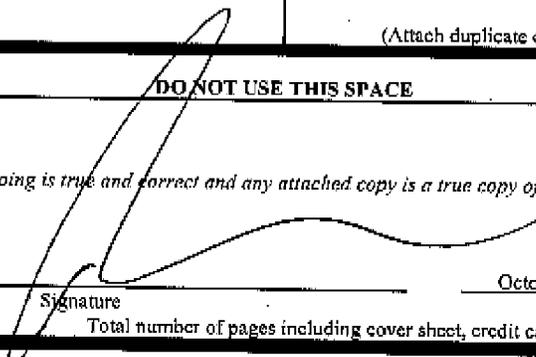
Additional numbers attached? Yes No

<p>5. Name and address of party to whom correspondence concerning document should be mailed:</p> <p>David W. Victor KONRAD RAYNES & VICTOR, LLP 315 S. Beverly Drive, Suite 210 Beverly Hills, CA 90212</p>	<p>6. Total number of applications and patents involved: [1]</p>
<p>7. Total fee (37 CFR 3.41).....\$ <u>40</u></p> <p><input checked="" type="checkbox"/> Enclosed; Credit Card Authorization Form <input type="checkbox"/> Authorized to be charged to deposit account</p>	<p>8. Deposit account number: 50-0585</p> <p>(Attach duplicate copy of this page if paying by deposit account)</p>

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9. Statement and signature.

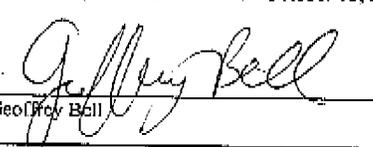
To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

<p>David W. Victor Name of Person Signing</p>	 <p>Signature</p>	<p>October 15, 2004 Date</p>
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Total number of pages including cover sheet, credit card authorization form and executed assignments: [6]

OMB No. 0651-0011 (exp. 4/94)

CERTIFICATE UNDER 37 CFR 1.8:
I hereby certify that this correspondence is being transmitted by facsimile to Assignment Recordation Services of the U.S. Patent and Trademark Office at 703-306-5995, or being deposited with the United States Postal Service with sufficient postage for first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box Alexandria, VA 22313-1450 on October 15, 2004.

 <p>Geoffrey Bell</p>	<p>10/15/04 Date</p>
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OP \$40.00 1087 1978

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ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

- (1) Fay Hua
- (2) Thomas J. Fitzgerald
- (3) Carl L. Deppisch
- (4) Gregory M. Chrysler

of San Jose
and State of California

of Phoenix
and State of Arizona

of Chandler
and State of Arizona

of Chandler
and State of Arizona

have invented certain improvement in

TITLE ELECTRONIC ASSEMBLY HAVING AN INDIUM WETTING LAYER ON A THERMALLY CONDUCTIVE BODY
 SERIAL NO. 10/871,978
 FILING DATE June 18, 2004

DATES THAT INVENTORS SIGNED THE DECLARATION and executed, respectively, a United States patent application therefore on (1) 9/1/04, 2004, (2) _____, 2004, (3) _____, 2004, and (4) _____, 2004

Whereas, INTEL CORPORATION, a corporation of Delaware, having a place of business at 2200 Mission College Blvd., Santa Clara, CA 95052. (hereinafter called INTEL CORPORATION), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to INTEL CORPORATION, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing of said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in said application to INTEL CORPORATION, its successors and assigns, and I hereby agree that INTEL CORPORATION may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by INTEL CORPORATION.

Signed and sealed

CITY DATE (1) at Santa Clara on Sept. 1, 2004, _____
 Fay Hua SIGNATURE INVENTOR

CITY DATE (2) at _____ on _____, 2004, _____
 Thomas J. Fitzgerald SIGNATURE INVENTOR

0077.0079

CITY (3) at _____
DATE on _____, 2004.

Carl L. Deppisch

SIGNATURE
INVENTOR

CITY (4) at _____
DATE on _____, 2004.

Gregory M. Chrysler

SIGNATURE
INVENTOR

0077.0079

ASSIGNMENT

Whereas, we

INVENTOR
AND CITY

- (1) Fay Hua
- (2) Thomas J. Fitzgerald
- (3) Carl L. Deppisch
- (4) Gregory M. Chrysler

of San Jose
and State of California
of Phoenix
and State of Arizona
of Chandler
and State of Arizona
of Chandler
and State of Arizona

have invented certain improvement in

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Whereas, INTEL CORPORATION, a corporation of Delaware, having a place of business at 2200 Mission College Blvd., Santa Clara, CA 95052, (hereinafter called INTEL CORPORATION), desires to acquire the entire right, title and interest in the said application and invention, and to any United States and foreign patents to be obtained therefore;

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Signed and sealed

CITY DATE (1) at _____
on _____, 2004,

Fay Hua SIGNATURE INVENTOR

CITY DATE (2) at Chandler, AZ
on 3rd Sept, 2004,

Thomas J. Fitzgerald SIGNATURE INVENTOR

TOTAL P.06

0077.0079

CITY
DATE

(3) at Chaworce, AZ
on September 2, 2004,

Carl L. Deppisch
Carl L. Deppisch

SIGNATURE
INVENTOR

CITY
DATE

(4) at Grand Lee AZ
on 2 Sept, 2004,

Gregory M. Chrysler
Gregory M. Chrysler

SIGNATURE
INVENTOR